

NCE2014ES

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE2014ES uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =20V,I_D =14A

 $R_{DS(ON)}$ <7 m Ω @ V_{GS} =4.5V

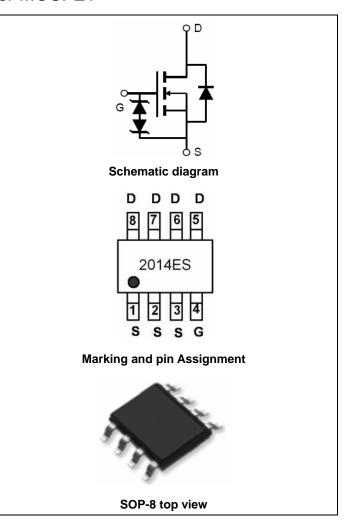
 $R_{DS(ON)}$ <9 m Ω @ V_{GS} =2.5V

ESD Rating: 2000V HBM

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM application
- Load switch



Package Marking and Ordering Information

	J	<u> </u>			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2014ES	NCE2014ES	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

The contract maximum statem go (1 % = 0 came con came motor)					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	20	V		
Gate-Source Voltage	V _{GS}	±10	V		
Drain Current-Continuous	I _D	14	А		
Pulsed Drain Current	I _{DM}	44	А		
Maximum Power Dissipation	P _D	3	W		
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}\!\mathbb{C}$		

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	42	°C/W

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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	20	22	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V,V _{GS} =0V	-	-	1	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±10 V , V_{DS} =0 V	-	-	±10	μΑ	
On Characteristics (Note 3)			•				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	0.6	0.8	1.2	V	
Desire Course On Otata Basistana	-	V _{GS} =4.5V, I _D =10A	-	5	7	mΩ	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =2.5V, I _D =5.5A	-	7	9		
Forward Transconductance	g FS	V _{DS} =5V,I _D =10A	30	-	-	S	
Dynamic Characteristics (Note4)	1						
Input Capacitance	C _{lss}	1/ 401/1/ 01/	-	1710	-	PF	
Output Capacitance	C _{oss}	$V_{DS}=10V, V_{GS}=0V,$	-	232	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	200	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	2.5	-	nS	
Turn-on Rise Time	t _r	V_{DD} =10V, R_L =1 Ω	-	7.2	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	49	-	nS	
Turn-Off Fall Time	t _f		-	10.8	-	nS	
Total Gate Charge	Qg	\/ 40\/ 40.4	-	17.5	-	nC	
Gate-Source Charge	Q _{gs}	$V_{DS}=10V, I_{D}=10A,$	-	1.5	-	nC	
Gate-Drain Charge	Q_{gd}	V _{GS} =4.5V	-	4.5	-	nC	
Drain-Source Diode Characteristics	<u> </u>		·				
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =10A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	14	Α	

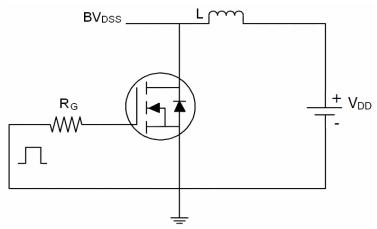
Notes:

- $\textbf{1.} \ \textbf{Repetitive Rating: Pulse width limited by maximum junction temperature.}$
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

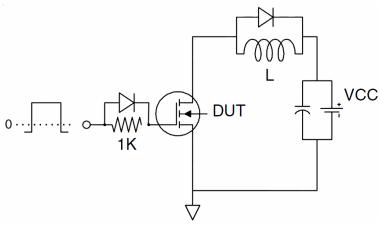
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Test Circuit

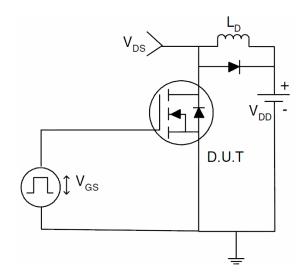
1) E_{AS} test Circuits



2) Gate charge test Circuit



3) Switch Time Test Circuit



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Typical Electrical and Thermal Characteristics

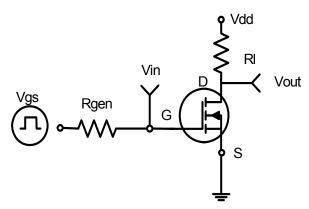
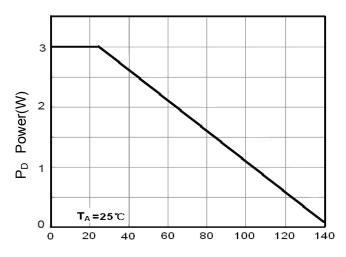


Figure 1:Switching Test Circuit



 T_J -Junction Temperature($^{\circ}$ C)

Figure 3 Power Dissipation

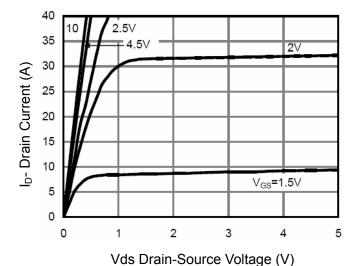


Figure 5 Output Characteristics

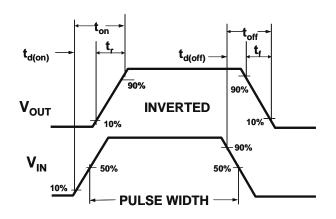


Figure 2:Switching Waveforms

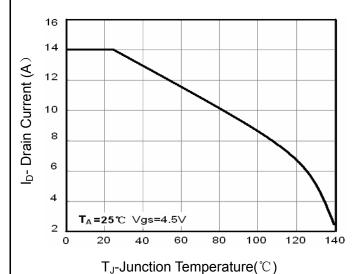


Figure 4 Drain Current

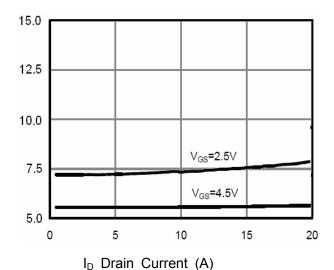


Figure 6 Drain-Source On-Resistance



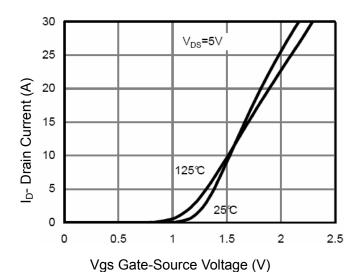
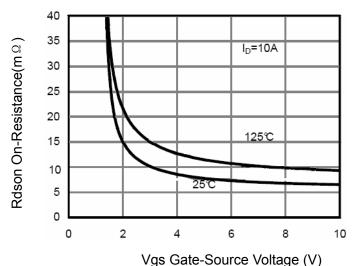
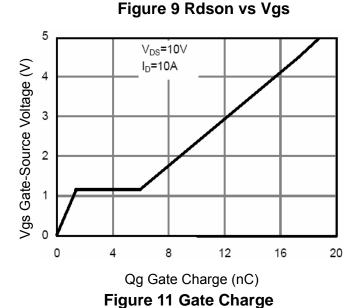


Figure 7 Transfer Characteristics





1.6 V_{GS}=2.5V Normalized On-Resistance I_D= 5.5A 1.4 V_{GS}=4.5V I_D=10A 1.2 1.0 8.0 50 75 0 25 100 125 150 175

Figure 8 Drain-Source On-Resistance

 T_J -Junction Temperature($^{\circ}$ C)

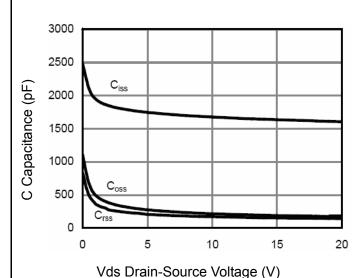
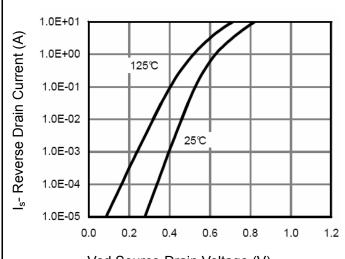


Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V) Figure 12 Source- Drain Diode Forward



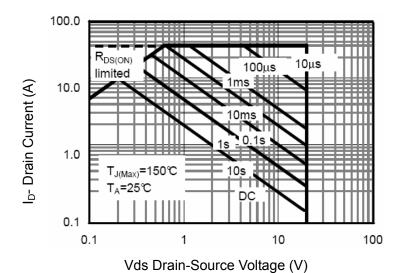


Figure 13 Safe Operation Area

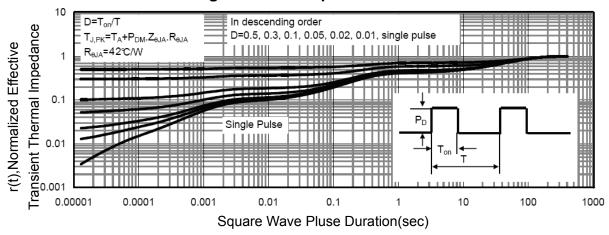


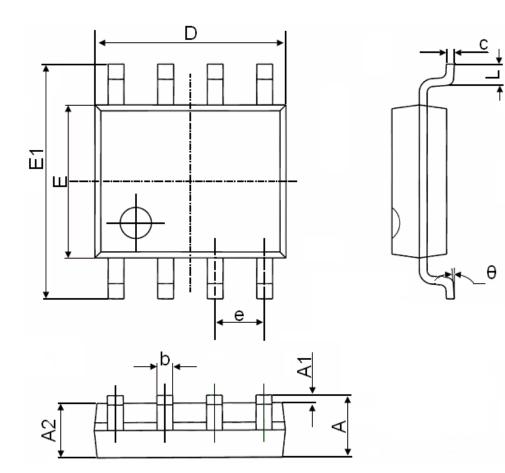
Figure 14 Normalized Maximum Transient Thermal Impedance

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SOP-8 Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270(BSC)		0.050(BSC)		
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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